DATA SHEET

PHOTOCOUPLER **PS2805-1, PS2805-4**

HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE SOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

NEC

The PS2805-1 and PS2805-4 are optically coupled isolators containing GaAs light emitting diodes and an NPN silicon phototransistor in a plastic SOP for high density applications.

This package has shield effect to cut off ambient light.

FEATURES

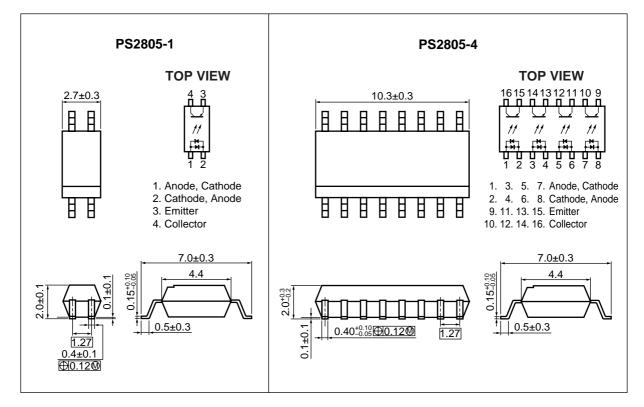
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4,16-pin SOP, Pin pitch 1.27 mm)
- High collector to emitter voltage (VCEO = 80 V)
- AC input response
- High-speed switching (tr = 3 μ s TYP., tr = 5 μ s TYP.)
- Ordering number of tape product: PS2805-1-F3, F4, PS2805-4-F3, F4
- Safety standards: PS2805-1, -4
 - UL approved: File No. E72422 (S)
 - BSI approved: No. 8188, 8189
 - VDE0884 approved (Option): PS2805-4 only

APPLICATIONS

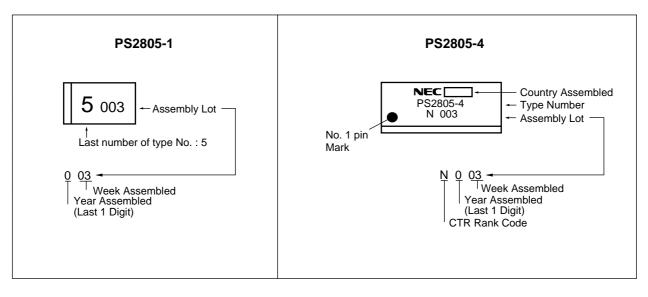
- · Programmable logic controllers
- Measuring instruments
- Hybrid IC

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* PACKAGE DIMENSIONS (UNIT: mm)



MARKING



ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS2805-1	4-pin SOP	50 pcs (Tape 50 pcs cut)	PS2805-1
PS2805-1-F3		Embossed Tape 3 500 pcs/reel	
PS2805-1-F4			
PS2805-4	16-pin SOP	Magazine Case 45 pcs	PS2805-4
PS2805-4-F3		Embossed Tape 2 500 pcs/reel	
PS2805-4-F4			

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2805-1	PS2805-4	
Diode	Forward Current (DC)	lf	±50		mA
	Power Dissipation Derating	⊿Po/°C	0.6	0.8	mW/°C
	Power Dissipation	PD	60	80	mW/ch
	Peak Forward Current [™]	IFP	±	1	А
Transistor	Collector to Emitter Voltage	Vceo	8	0	V
	Emitter to Collector Voltage	Veco	6	6	V
	Collector Current	lc	5	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.	.2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage ^{*2}		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		Tstg	-55 to +150		°C

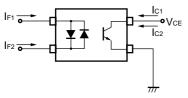
*1 PW = 100 μ s, Duty Cycle = 1 %

*2 AC voltage for 1 minute at TA = 25 °C, RH = 60 % between input and output

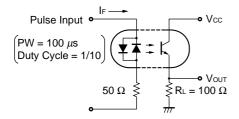
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = ±5 mA		1.1	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		30		pF
Transistor	Collector to Emitter Dark Current	Iceo	Vce = 80 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF)	CTR	IF = ±5 mA, Vce = 5 V	80		600	%
	CTR Ratio [™]	CTR1/ CTR2	IF = 5 mA, VCE = 5 V	0.3	1.0	3.0	
	Collector Saturation Voltage	V _{CE(sat)}	IF = ±10 mA, Ic = 2 mA			0.3	V
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 ¹¹			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time ^{*2}	tr	V_{CC} = 5 V, Ic = 2 mA, RL = 100 Ω		3		μs
	Fall Time ^{*2}	tr			5		

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

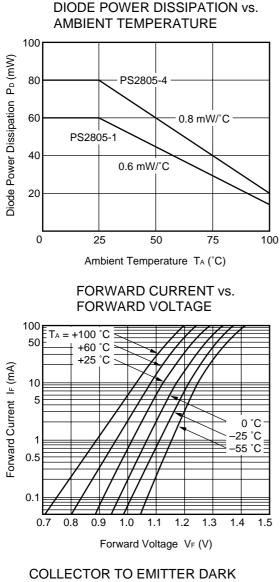
*1 CTR1 = Ic1/IF1, CTR2 = Ic2/IF2



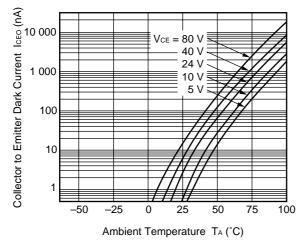
*2 Test circuit for switching time

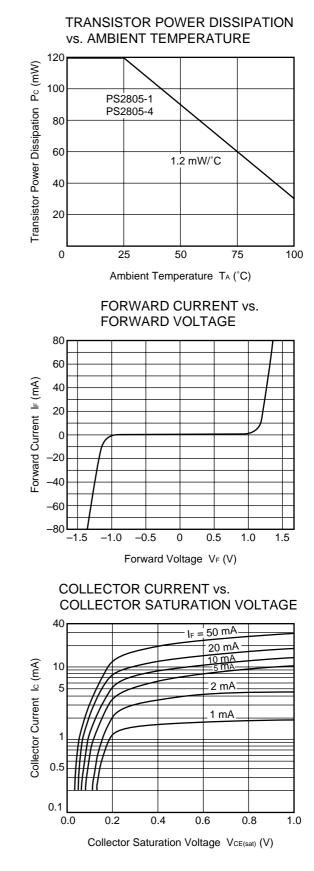


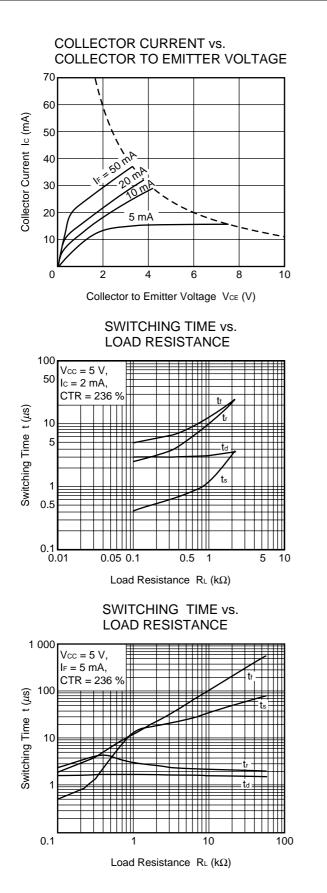
TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)

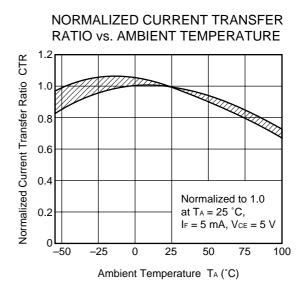




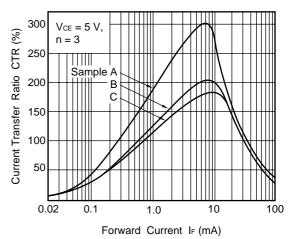




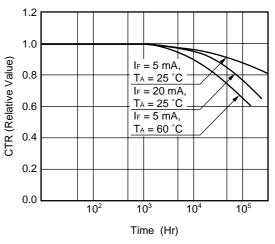


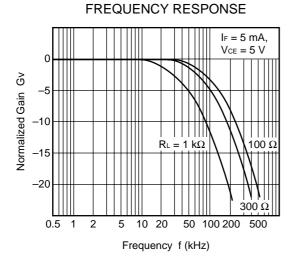


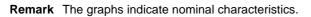
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



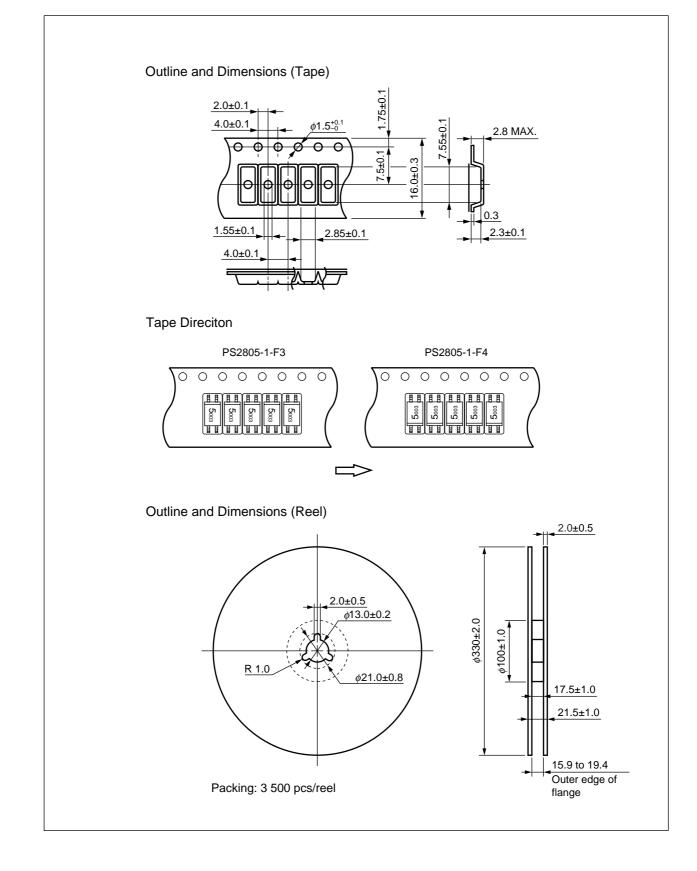
LONG TERM CTR DEGRADATION

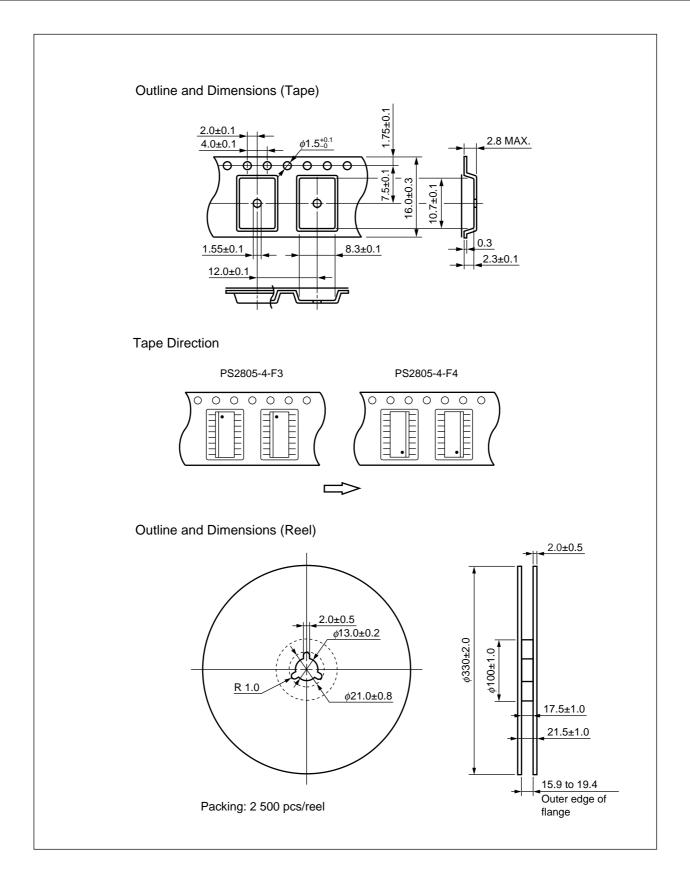






★ TAPING SPECIFICATIONS (UNIT: mm)





***** NOTES ON HANDLING

1. Recommended soldering conditions

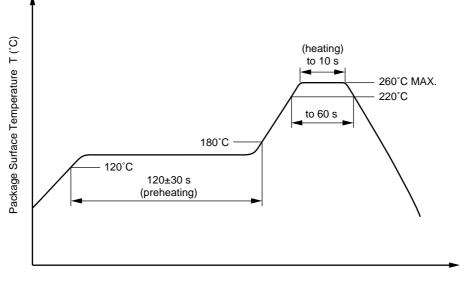
(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

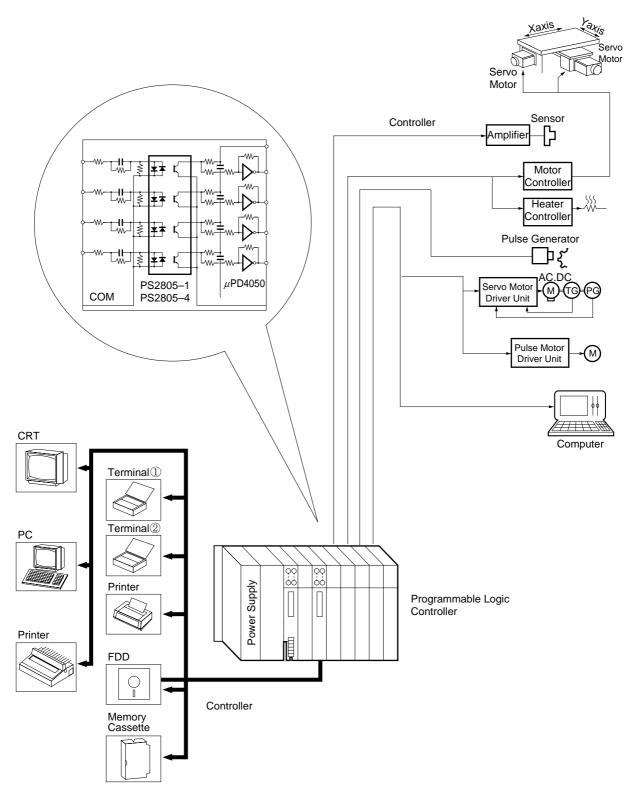
Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

★ USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

PROGRAMMABLE LOGIC CONTROLLERS EXAMPLE

Purpose: In-out interface



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M8E 00.4-0110

SAFETY INFORMATION ON THIS PRODUCT

Caution GaAs Products	The product contains gallium arsenide, GaAs. GaAs vapor and powder are hazardous to human health if inhaled or ingested.		
	Do not destroy or burn the product.		
	Do not cut or cleave off any part of the product.		
	Do not crush or chemically dissolve the product.		
	Do not put the product in the mouth.		
	Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.		

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